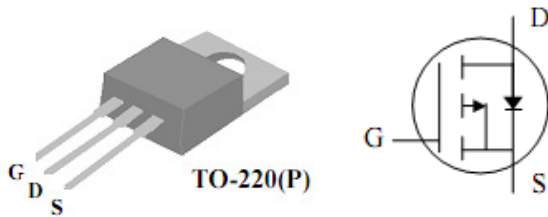




DESCRIPTION

ST9435GP is the P-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These device is particularly suited for low voltage application, notebook computer power management and other battery circuits where high-side switching.

PIN CONFIGURATION



FEATURE

- -30V/-10A, $R_{DS(ON)} = 50m\Omega$
@ $V_{GS} = -10V$
- -30V/-5A, $R_{DS(ON)} = 80m\Omega$
@ $V_{GS} = -4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- TO-220 package design

ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	VDSS	-30	V
Gate-Source Voltage	VGSS	±20	V
Continuous Drain Current ($T_J = 150^\circ C$)	ID	TA=25°C -15.0	A
		TA=100°C -8.0	
Pulsed Drain Current	IDM	-60	A
Power Dissipation	PD	62.5	W
Operation Junction Temperature	TJ	-55/150	°C
Storage Temperature Range	TSTG	-55/150	°C
Thermal Resistance-Junction to Ambient	RθJA	62	°C/W



-15.0A

ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250mA$	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0		-3.0	V
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V$			-1	uA
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=125^\circ C$			-250	
Drain-source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-10A$ $V_{GS}=-4.5V, I_D=-5A$		50 80	57 88	mΩ
Forward Transconductance	g_{fs}	$V_{DS}=-10V, I_D=-10A$		10		S
Diode Forward Voltage	V_{SD}	$I_S=-10A, V_{GS}=0V$			-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-24V$ $V_{GS}=-4.5V$ $I_D=-10A$		9	16	nC
Gate-Source Charge	Q_{gs}			1.6		
Gate-Drain Charge	Q_{gd}			4.3		
Input Capacitance	C_{iss}	$V_{DS}=-25V$ $V_{GS}=0V$ $F=1MHz$		575	750	pF
Output Capacitance	C_{oss}			80		
Reverse Transfer Capacitance	C_{rss}			75		
Turn-On Time	$t_{d(on)}$	$V_{DS}=-15V, R_G=3.3\Omega$ $I_D=-10A, V_{GS}=-10V$ $R_D=1.5\Omega$		6.8		nS
	t_r			46		
Turn-Off Time	$t_{d(off)}$			20		
	t_f			7		

TYPICAL CHARACTERISTICS

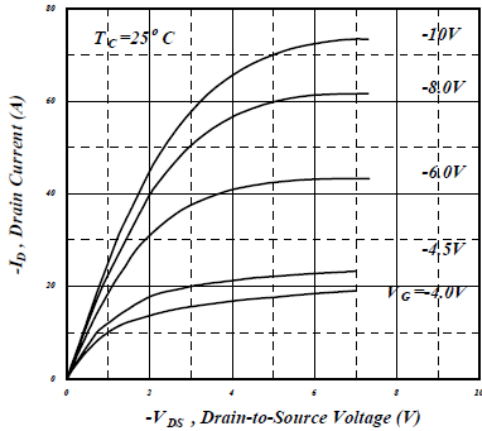


Fig 1. Typical Output Characteristics

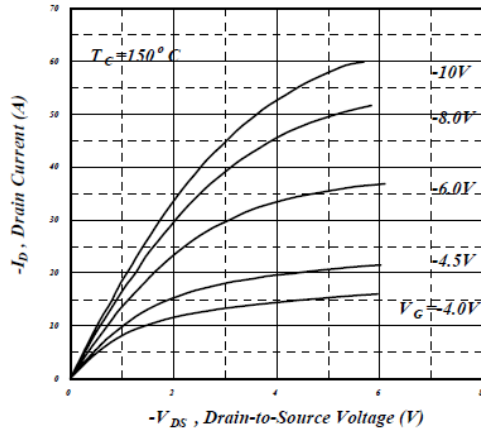


Fig 2. Typical Output Characteristics

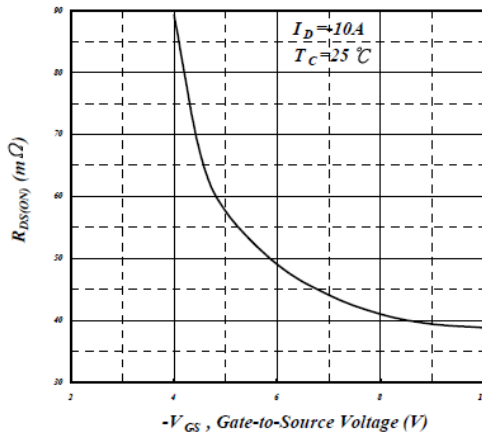


Fig 3. On-Resistance v.s. Gate Voltage

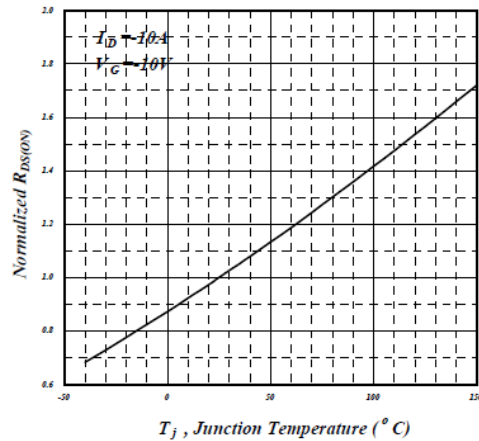
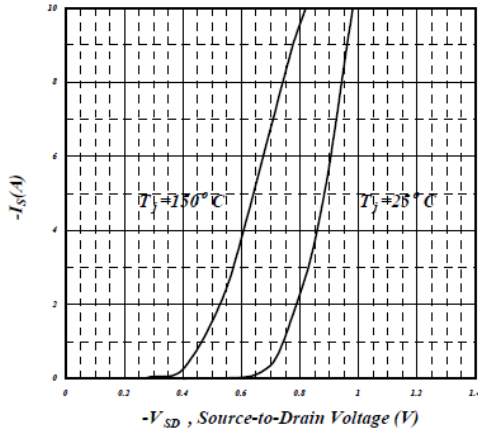
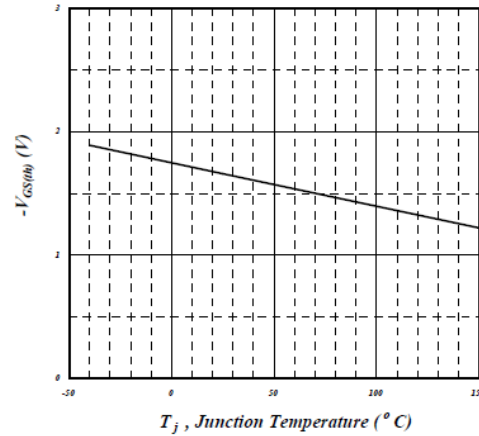
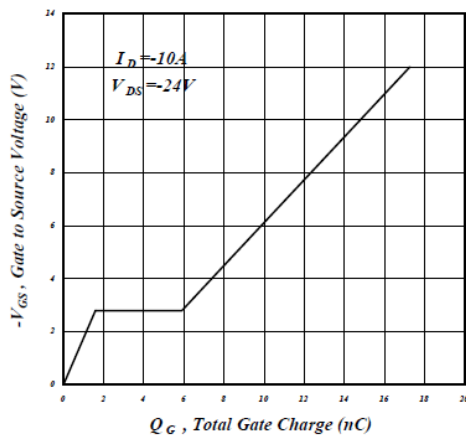
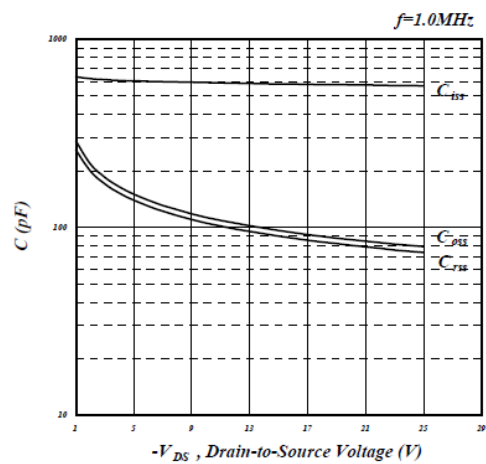


Fig 4. Normalized On-Resistance v.s. Junction Temperature

TYPICAL CHARACTERISTICS

Fig 5. Forward Characteristic of Reverse Diode

Fig 6. Gate Threshold Voltage v.s. Junction Temperature

Fig 7. Gate Charge Characteristics

Fig 8. Typical Capacitance Characteristics

TYPICAL CHARACTERISTICS

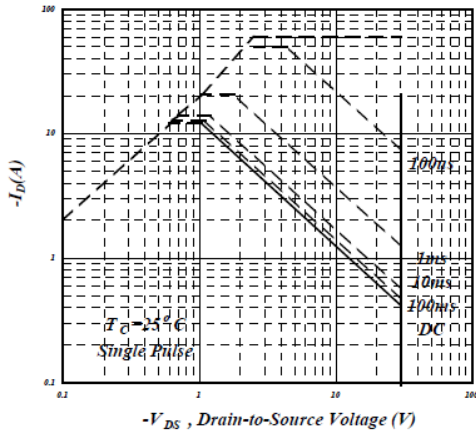


Fig 9. Maximum Safe Operating Area

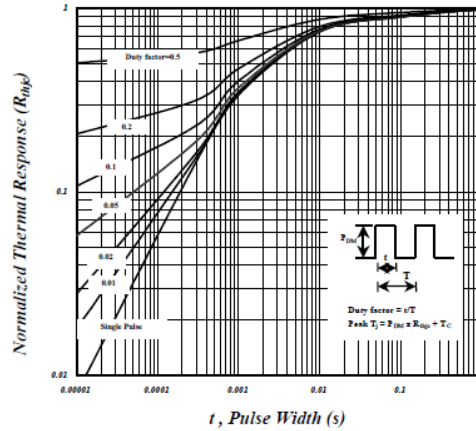


Fig 10. Effective Transient Thermal Impedance

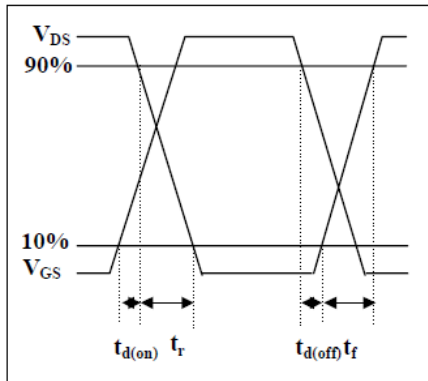


Fig 11. Switching Time Waveform

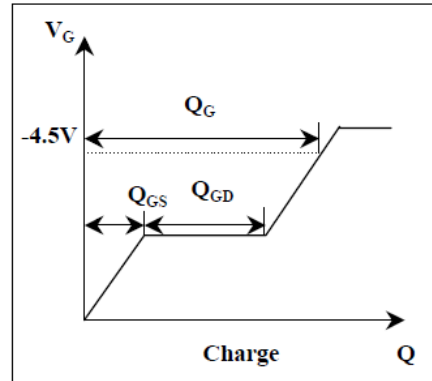
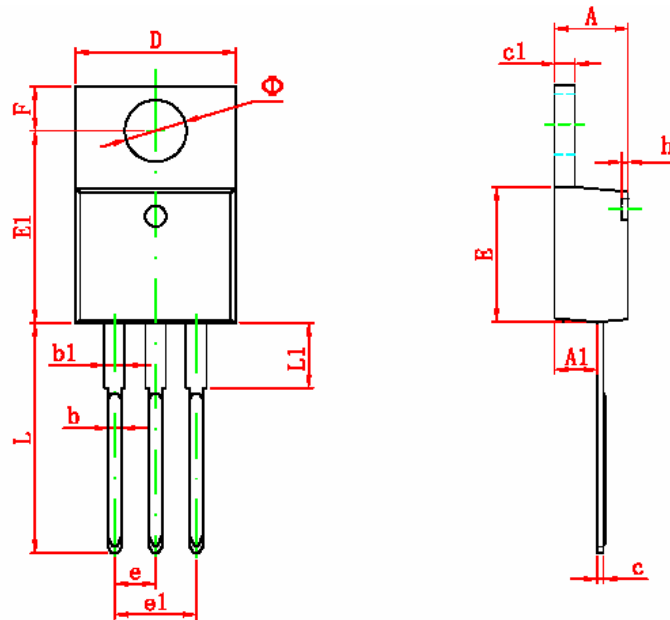


Fig 12. Gate Charge Waveform

TO-220-3L PACKAGE OUTLINE


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.470	4.670	0.176	0.184
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
E1	12.060	12.460	0.475	0.491
e	2.540 TYP		0.100 TYP	
e1	4.980	5.180	0.196	0.204
F	2.590	2.890	0.102	0.114
h	0.000	0.300	0.000	0.012
L	13.400	13.800	0.528	0.543
L1	3.560	3.960	0.140	0.156
• •	3.735	3.935	0.147	0.155